IRF830A

Vishay Siliconix



Power MOSFET

TO-220AB G G N-Channel MOSEET

PRODUCT SUMMARY					
V _{DS} (V)	500				
R _{DS(on)} (Ω)	V _{GS} = 10 V	1.4			
Q _g max. (nC)	24				
Q _{gs} (nC)	6.3				
Q _{gd} (nC)	11				
Configuration	Single				

FEATURES

- Low gate charge Q_g results in simple drive requirement
- Improved gate, avalanche and dynamic dV/dt RoHS ruggedness
- Fully characterized capacitance and avalanche voltage and current
- Effective Coss specified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

APPLICATIONS

- Switch mode power supply (SMPS)
- Uninterruptable power supply
- High speed power Switching
- TYPICAL SMPS TOPOLOGIES
- Two transistor forward
- Half bridge
- Full bridge

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF830APbF
Lead (Pb)-free and halogen-free	IRF830APbF-BE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	500	Ň	
Gate-source voltage			V _{GS}	± 30	V	
Continuous dusin surrent	V at 10 V	T _C = 25 °C T _C = 100 °C		5.0		
Continuous drain current	V _{GS} at 10 V	T _C = 100 °C	I _D	3.2	А	
Pulsed drain current ^a			I _{DM}	20	1	
Linear derating factor				0.59	W/°C	
Single pulse avalanche energy ^b			E _{AS}	230	mJ	
Repetitive avalanche current ^a			I _{AR}	5.0	A	
Repetitive avalanche energy ^a			E _{AR}	7.4	mJ	
Maximum power dissipation	T _C =	25 °C	PD	74	W	
Peak diode recovery dV/dt ^c			dV/dt	5.3	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	- °C	
Soldering recommendations (peak temperature) ^d	For 10 s			300		
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting torque			-	1.1	N · m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Starting T_J = 25 °C, L = 18 mH, R_g = 25 $\Omega,\,I_{AS}$ = 5.0 A (see fig. 12)
- c. $I_{SD} \le 5.0$ A, dI/dt ≤ 370 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C

d. 1.6 mm from case

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THERMAL RESISTANCE RAT	rings							
PARAMETER	SYMBOL	TYP		MAX	.		UNIT	
Maximum junction-to-ambient	R _{thJA}	-		62				
Case-to-sink, flat, greased surface	R _{thCS}	0.50)	-		°C/W		
Maximum junction-to-case (drain)	R _{thJC}	- 1.7		,				
	·							
SPECIFICATIONS ($T_J = 25 \degree C$,	unless otherw	ise noted)						
PARAMETER	SYMBOL	,		ONS	MIN.	TYP.	MAX.	UNIT
Static		I				1	1	1
Drain-source breakdown voltage	V _{DS}	V _{GS} =	0 V, I _D = 25	i0 μA	500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I	a = 1 mA	-	0.60	-	V/°C
Gate-source threshold voltage	V _{GS(th)}		V _{GS} , I _D = 25		2.0	-	4.5	V
Gate-source leakage	I _{GSS}	-	_{GS} = ± 30 V	-	-	-	± 100	nA
		V _{DS} =	500 V, V _{GS}	= 0 V	-	-	25	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 400 V,			-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V			-	-	1.4	Ω
Forward transconductance	9 _{fs}	V _{DS} =	50 V, I _D = 3	.0 A ^b	2.8	-	-	S
Dynamic		1				•	•	1
Input capacitance	C _{iss}		$V_{oo} = 0 V$		-	620	-	
Output capacitance	C _{oss}	$V_{GS} = 0 V, V_{DS} = 25 V, f = 1.0 MHz, see fig. 5$		-	93	-		
Reverse Transfer capacitance	C _{rss}			-	4.3	-		
Output capacitance	C _{oss}	V _{GS} = 0 V; V	_{DS} = 1.0 V, 1	f = 1.0 MHz		886		pF
Output capacitance	C _{oss}	V _{GS} = 0 V; V _I	_{DS} = 400 V,	f = 1.0 MHz		27		
Effective output capacitance	C _{oss} eff.	V _{GS} = 0 V;	$V_{DS} = 0 V t$	o 400 V ^c		39		
Total gate charge	Qg				-	-	24	nC
Gate-source charge	Q _{gs}	V _{GS} = 10 V		, V _{DS} = 400 V, 6 and 13 ^b	-	-	6.3	
Gate-drain charge	Q _{gd}		see lig.	o and 15	-	-	11	
Turn-on delay time	t _{d(on)}				-	10	-	
Rise time	t _r	V _{DD} =	250 V, I _D =	5.0 A,	-	21	-	ns
Turn-off delay time	t _{d(off)}	$R_g = 14 \Omega, F$			-	21	-	
Fall time	t _f	-		-	15	-		
Gate input resistance	Rg	f = 1 MHz, open drain		1.7	-	10.7	Ω	
Drain-Source Body Diode Characteris	tics							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	5.0	A	
Pulsed diode forward current ^a	I _{SM}			-	-	20		
Body diode voltage	V _{SD}	T _J = 25 °C, I _S = 5.0 A, V _{GS} = 0 V ^b		$I_{GS} = 0 V^{b}$	-	-	1.5	V
Body diode reverse recovery time	t _{rr}	-	-		-	430	650	ns
Body diode reverse recovery charge	Q _{rr}	T _J = 25 °C, I _F =	= 5.0 A, dl/d	t = 100 A/µs ^b	-	1.62	2.4	μC
Forward turn-on time	t _{on}	Intrinsic tu	rn-on time i	s negligible (tu	m-on is d	ominated	by Ls and	· ·

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}

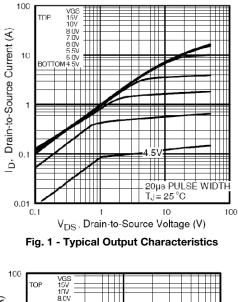
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



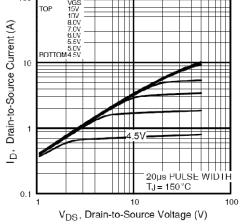


Fig. 2 - Typical Output Characteristics

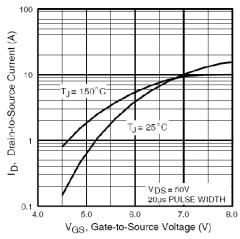


Fig. 3 - Typical Transfer Characteristics

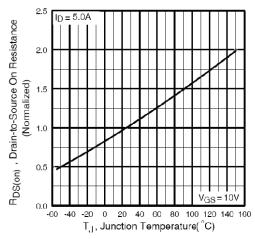


Fig. 4 - Normalized On-Resistance vs. Temperature

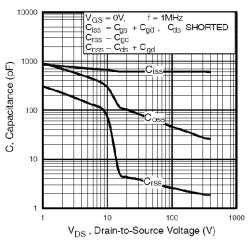


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

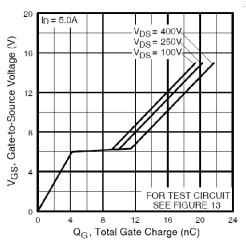


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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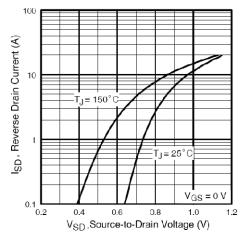


Fig. 7 - Typical Source-Drain Diode Forward Voltage

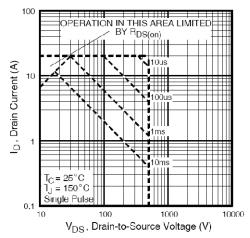


Fig. 8 - Maximum Safe Operating Area

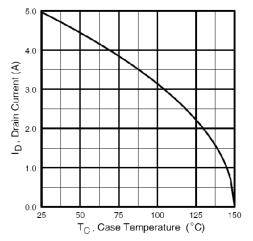


Fig. 9 - Maximum Drain Current vs. Case Temperature

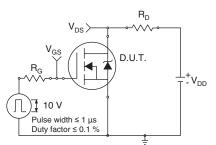


Fig. 10a - Switching Time Test Circuit

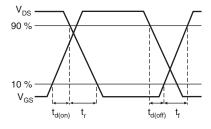


Fig. 10b - Switching Time Waveforms

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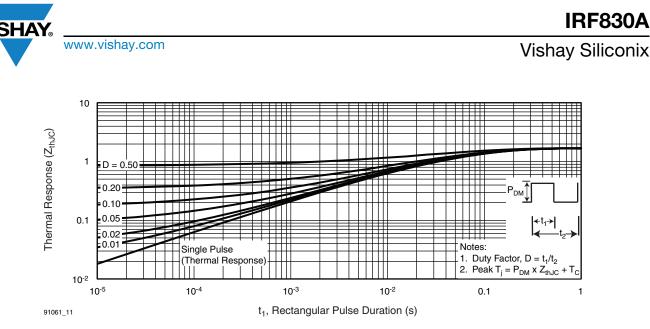


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

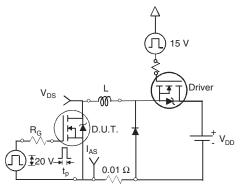


Fig. 12a - Unclamped Inductive Test Circuit

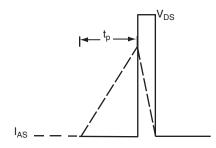


Fig. 12b - Unclamped Inductive Waveforms

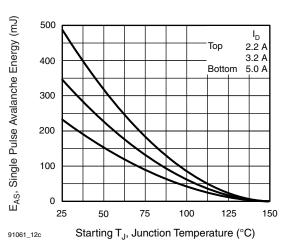


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

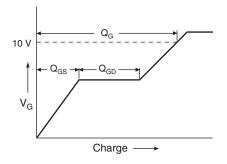
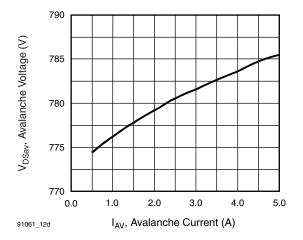


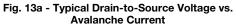
Fig. 12d - Basic Gate Charge Waveform



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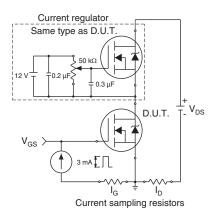
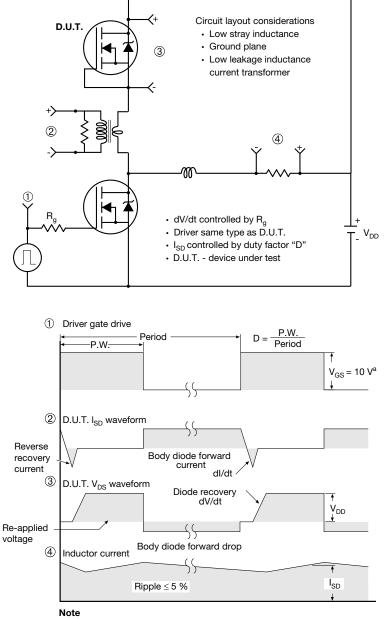


Fig. 13b - Gate Charge Test Circuit

6



Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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